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Number: PMP9667	Rev: A	Designed for: Public Release	Mod. Date: 4/16/2014
SVN Rev: Not in version control	Assembly Variant: 001	Project Title:	
Drawn By:	File: PMP9667_SCH.SchDoc	Sheet Title:	
Engineer: Enter name of project lead	Contact: http://www.ti.com/support	Sheet: 1 of 1	Size: B



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PCB Number: PMP9667
PCB Rev: Rev. A

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Update the Label Text in the Label Table as needed for each Assembly Variant.

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Label Table	
Variant	wassup
001	ChangeMe!
002	ChangeMe!

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